Features
- Drives External Power MOSFET
- Low LED Current (2.5mA)
- Requires No External Power Supply
- Load Voltages up to 65V
- High Reliability
- Small 8-pin Surface Mount Package
- $3750\text{V}_{\text{rms}}$ Input/Output Isolation
- Flammability Rating UL 94 V-0

Applications
- Industrial Controls
- Instrumentation
- Medical Equipment Isolation
- Electronic Switching
- I/O Subsystems
- Appliances

Approvals
- UL recognized component: File # E76270

Description
The CPC1580 optical gate driver provides isolated control of a discrete power MOSFET transistor without the need of an external power supply. Control of the power MOSFET transistor is accomplished by the application of sufficient input LED current to activate the driver circuitry.

On the load side, an external storage capacitor and an internal bootstrap diode enable the internal photovoltaic and gate driver circuitry to provide fast output switching characteristics by supplying the charge necessary to satisfy the MOSFET’s bias requirements.

Provided in a small 8-pin package, the CPC1580 provides $3750\text{V}_{\text{rms}}$ of input-to-output isolation.

Ordering Information

<table>
<thead>
<tr>
<th>Part</th>
<th>Description</th>
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</thead>
<tbody>
<tr>
<td>CPC1580P</td>
<td>8-Pin Flatpack (50/Tube)</td>
</tr>
<tr>
<td>CPC1580PTR</td>
<td>8-Pin Flatpack (1000/Reel)</td>
</tr>
</tbody>
</table>

Figure 1. CPC1580 DC Application Circuit Diagram
1. Specifications

1.1 Package Pinout

CPC1580P Pinout

<table>
<thead>
<tr>
<th>Pin#</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>N/C</td>
<td>Not connected</td>
</tr>
<tr>
<td>2</td>
<td>LED +</td>
<td>Positive input to LED</td>
</tr>
<tr>
<td>3</td>
<td>LED -</td>
<td>Negative input to LED</td>
</tr>
<tr>
<td>4</td>
<td>N/C</td>
<td>Not connected</td>
</tr>
<tr>
<td>5</td>
<td>V_G</td>
<td>Output, MOSFET Gate Control</td>
</tr>
<tr>
<td>6</td>
<td>V_L2</td>
<td>Load Voltage DC, ± Load Voltage AC</td>
</tr>
<tr>
<td>7</td>
<td>V_L1</td>
<td>+Load Voltage DC, ± Load Voltage AC</td>
</tr>
<tr>
<td>8</td>
<td>V_CAP</td>
<td>Storage Capacitor</td>
</tr>
</tbody>
</table>

1.2 Pin Description

1.3 Absolute Maximum Ratings

Absolute maximum electrical ratings are at 25°C.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Rating</th>
<th>Units</th>
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<tbody>
<tr>
<td>Blocking Voltage (V_DS)</td>
<td>65</td>
<td>V_P</td>
</tr>
<tr>
<td>Reverse Input Voltage</td>
<td>5</td>
<td>V</td>
</tr>
<tr>
<td>Input Control Current</td>
<td>50</td>
<td>mA</td>
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<tr>
<td>Peak (10ms)</td>
<td>1</td>
<td>A</td>
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<tr>
<td>Input Power Dissipation 1</td>
<td>150</td>
<td>mW</td>
</tr>
<tr>
<td>Output Power Dissipation 2</td>
<td>500</td>
<td>mW</td>
</tr>
<tr>
<td>Isolation Voltage (Input to Output)</td>
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<td>V_rms</td>
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<tr>
<td>Operational Temperature</td>
<td>-40 to +110</td>
<td>°C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>-40 to +125</td>
<td>°C</td>
</tr>
</tbody>
</table>

1. Derate linearly 1.33mW/°C
2. Derate linearly 6.0mW/°C

Absolute maximum ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

1.4 ESD Rating

ESD Rating (Human Body Model)

<p>| | |</p>
<table>
<thead>
<tr>
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<tr>
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<td>1000 V</td>
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1.5 Recommended Operating Conditions

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<td>I_F</td>
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<td>Forward Voltage Drop</td>
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<td>V</td>
</tr>
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<td>Operating Temperature</td>
<td>T_A</td>
<td>-40</td>
<td>+110</td>
<td>°C</td>
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</table>
1.6 General Conditions

Unless otherwise specified, minimum and maximum values are guaranteed by production testing. Typical values are characteristic of the device at 25°C, and are the result of engineering evaluations. They are provided for informational purposes only, and are not part of the manufacturing testing requirements. Unless otherwise noted, all electrical specifications are listed for \( T_A=25°C \).

1.7 Electrical Specifications

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Conditions</th>
<th>Symbol</th>
<th>Min</th>
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<tr>
<td>Gate Voltage</td>
<td>( I_F=2.5\text{mA} )</td>
<td>( V_{GS} )</td>
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<td>V</td>
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<td>( I_F=5\text{mA} )</td>
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<td></td>
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<td></td>
<td>(-40°C&lt;T_A&lt;110°C)</td>
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<td>Capacitor Voltage</td>
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<td>( V_{CAP} )</td>
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<td>Gate Drive Capability</td>
<td>( I_F=2.5\text{mA}, V_{GS}=0V, V_{CAP}=15V )</td>
<td>( I_{G}_source )</td>
<td>2</td>
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<td>mA</td>
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<tr>
<td></td>
<td>( I_F=0\text{mA}, V_{GS}=8V, V_{CAP}=8V )</td>
<td>( I_{G}_sink )</td>
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<td>( I_F=0\text{mA}, V_{GS}=4V, V_{CAP}=4V )</td>
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<td>0.16</td>
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<td>( t_{off1} )</td>
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<td>Off-State Leakage Current</td>
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<td>( \mu\text{A} )</td>
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<td><strong>LED Characteristics</strong></td>
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<td>Forward Voltage Drop</td>
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<td>V</td>
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<td>Input Dropout Current</td>
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<td>( I_F )</td>
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<td>( I_R )</td>
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<td>( \mu\text{A} )</td>
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<td><strong>Common Characteristics</strong></td>
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<td>Input to Output Capacitance</td>
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<td>( C_{IO} )</td>
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<td>pF</td>
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</tbody>
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1.8 Performance Data*

* Unless otherwise noted, data presented in these graphs is typical of device operation at 25ºC. For guaranteed parameters not indicated in the written specifications, please contact our application department.
2. Introduction

The CPC1580 Isolated Gate Driver uses an efficient optocoupler design to provide remote gate drive current to a MOSFET, while providing 3750Vrms of isolation between the LED control current input and the MOSFET gate drive output. The CPC1580 is used in conjunction with a MOSFET transistor for remote switching of DC loads (Figure 1) and two MOSFETs and a diode at low-frequency AC rates (Figure 2) where isolated power is unavailable.

By selecting a few external components, the charge capacitor and resistors, the designer has control over the operating parameters of the CPC1580 circuit, and can customize the circuit to accommodate the requirements of a wide selection of MOSFETs.

The designer just needs to know the MOSFET total gate charge (QG), and with this information a capacitor can be chosen. The capacitance of the storage capacitor, C_ST, should be greater than or equal to QG.

3. Functional Description

The CPC1580 is operational when sufficient input control current is flowing, the LED is turned on, and the gate current is flowing. The LED illuminates the photovoltaics (converts light into electrical power, or photocurrent), which provides current to turn on the NPN bipolar transistor. The NPN transistor then allows for charge to go to the gate of the MOSFET. When an external storage capacitor is added to the CPC1580, the photocurrent that is produced turns on the NPN bipolar transistor and provides the charge (I x t = Q) plus the charge of the capacitor to turn on the MOSFET rapidly. If sufficient input control current is not flowing, the LED is turned off, and gate current is not flowing. The LED is off due to the V_F<< the minimum forward voltage required and not enough current being applied. This turns on the PNP bipolar transistor, which provides a path for QG to discharge to V_S.

When V_L is first applied, the external storage capacitor begins to charge. The value of the storage capacitor should be equal to or greater than the MOSFET gate capacitance: this will ensure proper operation. The charge is sent through a bootstrap diode to prevent the charge from escaping and discharging through a turned-on MOSFET. The input control current is applied, then the charge is transferred from the storage capacitor through the NPN bipolar transistor, along with the charge from the photovoltaics, to the MOSFET gate to accomplish a rapid turn-on. After the capacitor has discharged and the MOSFET has turned on, the photocurrent from the input optocoupler continues to flow into the gate to keep the MOSFET turned on.

When the input control current is removed, the gate current stops flowing and the PNP bipolar transistor is on and is discharging the MOSFET gate. The MOSFET is now off. At this point, the capacitor begins to recharge for the next turn-on cycle.

4. Device Configuration

4.1 LED Resistor

LED resistor selection should comply with the recommended operating conditions. This will provide reliability to the design, and should help with temperature. The CPC1580 is capable of being operated at up to the maximum ratings, but this is not recommended. It will shorten the life-span of the device and could cause temperature problems that will produce inaccuracies. The reason for using a higher I_F current is to provide for faster turn-on. Proper design will have to be used to decide on the needs of the application. The equation used to calculate the resistor value:

\[ R_{LED} = \frac{V_{IN} - V_F}{I_F} \]

- \( I_F \) = Input Control Current
- \( V_{IN} \) = Input Power Source
- \( V_F \) = Forward Voltage Drop of LED
- \( R_{LED} \) = Input Resistor connected to LED

4.2 Storage Capacitor Selection

The storage capacitor (C_ST) enables the part to turn on quickly by holding a reservoir of charge to be transferred to the gate of the MOSFET. The turn-off cycle does not depend on the storage capacitor.

The equation used to calculate the value of the charge storage capacitor is:

\[ C_{ST} \geq \frac{Q_G}{V_{LOAD} \cdot V_{CAP}} \] (FARADS)
Where $V_{\text{CAP}} \geq 15\text{V}$ and $Q_G$ is the total gate charge (listed in the MOSFET data sheet).

The storage capacitor needs to deliver enough charge to the gate without going below the 15V required for switching the MOSFET. This means that $V_{\text{LOAD}}$ must equal, at a minimum, 15.7V. The part can operate at a lower voltage, but the MOSFETs will be turned on slowly.

The proper selection of a capacitor is important. The rated voltage should be at least two to three times the $V_{\text{CAP}}$. The extra margin is important because some capacitors lose capacitance when operated at their full rated voltages. When selecting a capacitor, be sure to add in their tolerance because of capacitor drift. For example:

- $C_{ST} = 1\mu F$, 20% tolerance; $V_{\text{CAP}} = 15\text{V}$
- $1\mu F \times 20\% = 0.2\mu F$
- $1\mu F + 0.2\mu F = 1.2\mu F$

Capacitance drift can also be due to temperature and the dielectrics used. Therefore, the required capacitor value is $1.2\mu F$ or next higher value, and the capacitor voltage rating must be at least 30 volts. It is recommended to go higher in the voltage rating if engineering restraints permit, such as 50V.

Temperature requirements for capacitors are application-specific. The designer must know the intended operating temperature when selecting capacitors. The information given above should be applied to other capacitors discussed in this data sheet.

The CPC1580 can deliver 32nC at the rated operating speed and will operate with much larger loads ($>4\mu F$) with slower turn-on and turn-off times.

Note: Care must be taken to minimize any capacitor-to-ground leakage current path between pins 7 and 8 (MOSFET gate current) and between pins 5 and 6. Leakage currents will discharge the storage capacitor and, even though the device is already on, will become a load to the photocurrent, which keeps the gate voltage on. The gate voltage will be reduced if $>500nA$ of leakage is present, therefore the combined impedance from pin 8 to pin 7, pin 5, and pin 6, capacitor current, and MOSFET current must be $>20M\Omega$ over the temperature rating of the part.

### 4.3 Transistor Selection

The CPC1580 charges and discharges an external MOSFET transistor. The selection of the MOSFET transistor is determined by the user to meet the specific power requirements for the load. The CPC1580 output voltage is listed in the specifications, but as mentioned earlier, there must be little or no gate leakage.

Another parameter that plays a significant role in the selection of the transistor is the gate drive voltage available from the part. The CPC1580 uses photovoltaic cells to collect the optical energy generated by the LED; to generate more voltage, the photovoltaic diodes are stacked. The voltage change of the photovoltaic stack reduces with increased temperature. The user must select a transistor that will maintain the load current at the maximum temperature, given the $V_{\text{GS}}$ in Section 1.7, the CPC1580 Table of Electrical Specifications.

The example circuits shown in Figure 1 and Figure 3 use “logic level” MOSFETs for each design to maintain the load described.

#### 4.3.1 Transistor Switching Characteristics

The primary characteristics of the application switching are $t_{\text{on}}$, $t_{\text{off}}$, $t_{\text{RISE}}$, $t_{\text{FALL}}$, and the recovery time of the storage capacitor, $t_{\text{CHG}}$. These parameters are dependent on the MOSFET selection and need to be reviewed in light of the application requirements.

The CPC1580 turns on the MOSFET transistor to the specified $V_{\text{GS}}$ after the $t_{\text{on}}$ delay. Similarly the $t_{\text{off}}$ delay is the amount of time until the LED is turned off and the capacitive load discharges to the level in the CPC1580 specification. For MOSFETs with larger or smaller required gate charge the $t_{\text{on}}$ and $t_{\text{off}}$ will be proportionately faster and slower, but it is not a linear relationship.

To calculate the nominal rise time of the transistor’s drain voltage, $V_D$:

$$t_{\text{RISE,VD}} \approx \frac{V_{\text{LOAD}} \times C_{\text{RSS}}}{I_{G_{\text{SINK}}}} \quad \text{(SECONDS)}$$

To calculate the nominal fall time of the transistor’s drain voltage, $V_D$:

$$t_{\text{FALL,VD}} \approx \frac{V_{\text{LOAD}} \times C_{\text{RSS}}}{I_{G_{\text{SOURCE}}}} \quad \text{(SECONDS)}$$
Where $C_{RSS}$ is the MOSFET gate-drain capacitance (averaged over the switching voltage range) found in the MOSFET data sheet, $I_{G\_SINK}$ is the gate sinking current of the CPC1580, and $I_{G\_SOURCE}$ is the gate driving ability. The maximum value of $t_{RISE}$ is limited by the CPC1580 unloaded discharge characteristic and should be reviewed in light of the final application component selections if critical.

The value for the charge time, $t_{CHG}$, is due to external component selection. The storage capacitor charge recovery time (seconds) is computed as:

$$ t_{CHG} = - (400 + R_{OVP}) \cdot (C_{ST} + C_{OVP}) \cdot \ln \left( \frac{V_{LOAD} \cdot V_{FINAL}}{Q_G} \right) $$

Which reduces to:

$$ t_{CHG} \approx - (400 + R_{OVP}) \cdot (C_{ST} + C_{OVP}) \cdot 3 $$

**Note:** The CPC1580 is ideal to use where remote power is otherwise unavailable. If the LED is also powered remotely, care must be taken to ensure that parasitic transient signals are reliably filtered from the input control signal. Large transient currents will mutually couple energy between cables and a simple R-C filtering of the CPC1580 input may be sufficient to suppress false turn-on.

**Figure 2. CPC1580 AC Application Circuit**

5. CPC1580 Over-Voltage Protection

Over-voltage protection is generally required for the CPC1580 because of parasitic inductance in the load, wires, board traces, and axial leads of protectors. Purely resistive loads or loads with low voltage switching may be able to rely on the transistor to handle any parasitic energy and thereby not require protection for the CPC1580. For very low inductance loads and traces, over-voltage suppression may be handled with a simple R-C filter consisting of $R_{OVP}$ and $C_{OVP}$ or by use of a free-wheeling diode (see Figure 3). For more moderate load inductance, or remote switching of a load (i.e. through a long cable) a voltage suppressor can be used. For heavily inductive loads only a free-wheeling diode, $D_{OVP}$ connected
across the load element is recommended, see Figure 3.

The energy not consumed in switching losses must be absorbed by the over-voltage protection element. Most protective devices are designed to withstand certain peak power, in the case of a Transient Voltage Suppressor (TVS); or maximum avalanche energy, in the case of a MOSFET. Understanding the switching losses and load dynamics is absolutely essential.

One simple way to reduce the amount of stored inductive energy is to increase the energy dissipated in the switch. This can be accomplished by adding a larger capacitor in parallel with the gate-drain connection of the MOSFET, however care must be taken so that the rise time and peak current do not exceed the Safe Operating Area (SOA) rating of the transistor.

The consequence of increasing the gate-drain effective capacitance is reduced dV/dt tolerance.

When used in a circuit with an inductive load, precautions must be taken to prevent damage to the circuit from inductively generated voltage spikes. The circuit shown in Figure 3 includes such protection across the inductive load.

5.1 Other Protection Techniques

Switching loads with higher inductance characteristics requires consideration of other circuit protection techniques, device ratings, or protector types. Of paramount importance is that the designer know the characteristics of the load being switched.

5. CPC1580 Over-Voltage Protection for Inductive Loads

6. Application Switching Losses

During the transition intervals, the application and load components change energy states and, in the process, incur switching losses. The switching losses are manifested as heat in the application circuit and must be addressed by the designer to ensure that no one component exceeds its power rating. The designer must understand the details of the load behavior in order to adequately size and protect the application circuit. There are three general cases to observe: (1) purely resistive loads, (2) inductive/resistive loads, and (3) loads with significant capacitance. Inductors and capacitors are energy storage elements that require special consideration for switching.

During the switching periods, energy is conserved. Inductors turning off transfer their stored energy to MOSFET switching losses, to the capacitance of the load and application circuit, and to the protector.

During the turn-on interval, the inductor energy is zero, and so the capacitive energy in the load and parasitic elements of the switching application must be

Figure 3. CPC1580 Over-Voltage Protection for Inductive Loads
dissipated by the MOSFET, in order for the load to change state.

To calculate the stored inductive energy in Joules:

\[ E_L = \frac{1}{2} \cdot L \cdot I_{LOAD}^2 \]

### 6.1 Resistive Load Losses: The Ideal Case

For purely resistive loads, the energy dissipated by changing states occurs primarily in the MOSFET.

The equation describing MOSFET energy dissipation during rise time, in Joules, is:

\[ E_{RISE} \geq V_{LOAD}^2 \cdot \frac{C_{RSS}}{I_{G_SINK}} \cdot \frac{I_{LOAD}^2}{6} = \frac{P_{LOAD}}{6} \cdot t_{RISE} \]

The average power of the MOSFET for any load type in Watts is:

\[ P_{AVG} = I_{LOAD}^2 \cdot R_{DSAT} \cdot D + f_{SWITCH} \cdot (E_{RISE} + E_{FALL}) \]

Where \( f_{SWITCH} \) is the application switching frequency; \( R_{DSAT} \) is the MOSFET’s on-resistance; \( D \) is the switch’s operational duty cycle: \( D = t_{on}/(t_{on}+t_{off}) \); and \( E_{FALL} \) is MOSFET energy dissipation during fall time, in Joules.

### 6.2 Inductive/Resistive Loads

If the load is resistive and inductive, and the inductance doesn’t saturate, the load current during turn off, \( t_{RISE} \), in Amps is:

\[ I_{LOAD}(t) = \frac{V_{LOAD}}{R_{LOAD}} \cdot \frac{I_{G_SINK}}{C_{RSS}} \cdot \left( \frac{I_{LOAD}}{R_{LOAD}} \cdot \frac{C_{LOAD}}{R_{LOAD}} \cdot 1 - 1 + e^{-\frac{R_{LOAD}}{L_{LOAD}} \cdot t} \right) \]

and the MOSFET drain voltage during turn off, \( t_{RISE} \), in Volts is:

\[ V_{DRAIN}(t) = \frac{I_{G_SINK}}{C_{RSS}} \cdot t \]

The instantaneous power in the MOSFET will be the product of the two equations and the energy will be the integral of the power over time.

### 6.3 Capacitive Loads

The energy absorbed by the MOSFET for loads that are more capacitive in nature occurs during the MOSFET turn-on as opposed to the turn-off. The energy absorbed by the MOSFET will be a function of the load, the TVS (or other protector), and the MOSFET drain capacitance. The MOSFET energy, \( E_{FALL} \), in Joules is:

\[ E_{FALL} = \frac{1}{2} \cdot (C_{TVS} + C_{OSS} + C_{LOAD}) \cdot V_{LOAD}^2 \]

\( C_{OSS} \) is the MOSFET output capacitance found in the data sheet. As mentioned earlier, the MOSFET switching losses occur at different times, either rising or falling, so loads with a combination of inductance and capacitance can also be calculated by the energy equations described above.

### 6.4 dV/dt Characteristics

The application circuit shown in Figure 1 dissipates significant energy caused by large dV/dt events. Fault voltages across the MOSFET will turn it on for the same reason the part turns off slowly. For dV/dt events \( > I_{G_SINK}/C_{RSS} \) (from Equation 2) the application circuit will dissipate energy proportional to the \( C_{RSS} \) and \( g_{FS} \) (forward conductance) of the selected transistor. \( C_{RSS} \) is a function of the transistor’s on-resistance and current/power capability, so higher load designs are more sensitive.

The CPC1580 provides an internal clamp to protect the gate of the MOSFET from damage in such an event. The part can withstand 100mA for short periods, like dV/dt transients.

### 7. Design Switching Frequency

The maximum switching frequency is the last design value to be calculated, because the over-voltage protection and the storage capacitor play a significant role in determining the result. Inasmuch as those factors are already determined, the following gives a good approximation for the maximum switching frequency. The maximum switching frequency is a function of the gate charge of the MOSFET, the storage capacitor (\( C_{ST} \)), and \( R_{OVP} \). The maximum switching frequency relationship in Hz is:

Where:
\[ f_{\text{MAX}} \leq \frac{1}{M} \cdot (t_{\text{on}} + t_{\text{off}} + (t_{\text{RISE,VD}} \mid t_{\text{CHG}}) + t_{\text{FALL,VD}})^{-1} \]

- \( M = 3 \) (multiplication factor for temperature and process variations)
- \( t_{\text{on}} \) and \( t_{\text{off}} \) are CPC1580 data sheet parameters
- \( t_{\text{RISE,VD}} \) is the rise time of the drain voltage and \( t_{\text{CHG}} \) is the charge time of the storage capacitor and the over-voltage protection circuitry as derived in Section 4.3: choose the greater of \( t_{\text{RISE,VD}} \) or \( t_{\text{CHG}} \) for the calculation
- \( t_{\text{FALL,VD}} \) is the fall time across the transistor

There is no minimum switching frequency since the CPC1580 uses photovoltaic diodes to keep the output charged while LED current flows.
8. Manufacturing Information

8.1 Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingestion. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

<table>
<thead>
<tr>
<th>Device</th>
<th>Moisture Sensitivity Level (MSL) Classification</th>
</tr>
</thead>
<tbody>
<tr>
<td>CPC1580</td>
<td>MSL 1</td>
</tr>
</tbody>
</table>

8.2 ESD Sensitivity

This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

8.3 Soldering Profile

Provided in the table below is the Classification Temperature \( (T_C) \) of this product and the maximum dwell time the body temperature of this device may be \( (T_C - 5)°C \) or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of J-STD-020 must be observed.

<table>
<thead>
<tr>
<th>Device</th>
<th>Classification Temperature ( (T_C) )</th>
<th>Dwell Time ( (t_p) )</th>
<th>Max Reflow Cycles</th>
</tr>
</thead>
<tbody>
<tr>
<td>CPC1580</td>
<td>260°C</td>
<td>30 seconds</td>
<td>3</td>
</tr>
</tbody>
</table>

8.4 Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.
8.5 CPC1580P Package

8.6 CPC1580PTR Tape and Reel Specification

For additional information please visit our website at: www.ixysic.com

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Specification: DS-CPC1580-R02
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